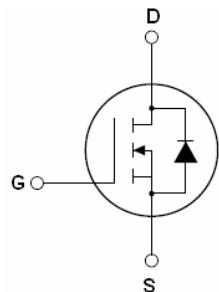


## N-Channel Trench Power MOSFET

<p><b>General Description</b></p> <p>The CS95118 is SGT MOSFET designed for high current switching applications. Rugged EAS capability and ultra low <math>R_{DS(ON)}</math> is suitable for PWM, load switching applications.</p> <p><b>Features</b></p> <ul style="list-style-type: none"> <li>● <math>V_{DS}=95V</math>; <math>I_D=118A</math> @ <math>V_{GS}=10V</math>;  <math>R_{DS(ON)}&lt;6.3m\Omega</math> @ <math>V_{GS}=10V</math></li> <li>● Ultra Low On-Resistance</li> <li>● High UIS and UIS 100% Test</li> </ul> <p><b>Application</b></p> <ul style="list-style-type: none"> <li>● Hard Switched and High Frequency Circuits</li> <li>● Uninterruptible Power Supply</li> </ul>	  <p>To-220 Top View      Schematic Diagram</p> <p><math>V_{DS} = 95V</math></p> <p><math>I_D = 118A</math></p> <p><math>R_{DS(ON)} = 5.2m\Omega</math></p>
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### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
CS95118	CS95118	TO-220	-	-	-

**Table 1. Absolute Maximum Ratings (TA=25°C)**

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0V$ )	95	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0V$ )	$\pm 20$	V
$I_D$ (DC)	Drain Current (DC) at $T_c=25^\circ C$	118	A
$I_D$ (DC)	Drain Current (DC) at $T_c=100^\circ C$	84	A
$I_{DM}$ (pulse)	Drain Current-Continuous@ Current-Pulsed <sup>(Note 1)</sup>	472	A
$P_D$	Maximum Power Dissipation( $T_c=25^\circ C$ )	139	W
	Derating Factor	0.93	W/°C
$E_{AS}$	Single Pulse Avalanche Energy <sup>(Note 2)</sup>	625	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 175	°C

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2.EAS condition: $T_J=25^\circ C, V_{DD}=40V, V_G=10V, R_G=25 \Omega$

**Table 2. Thermal Characteristic**

Symbol	Parameter	Value	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	---	1.077	°C/W

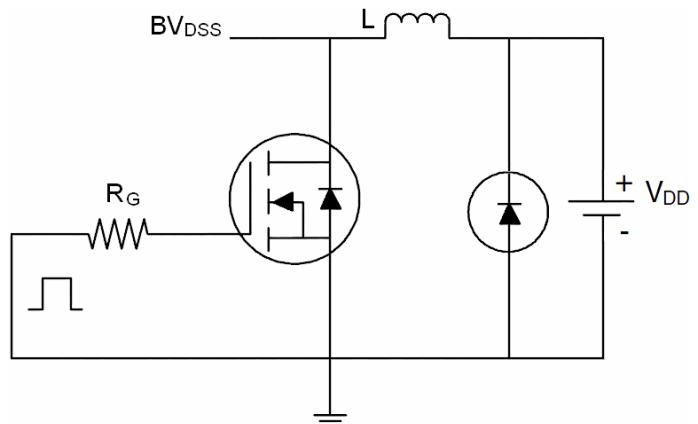
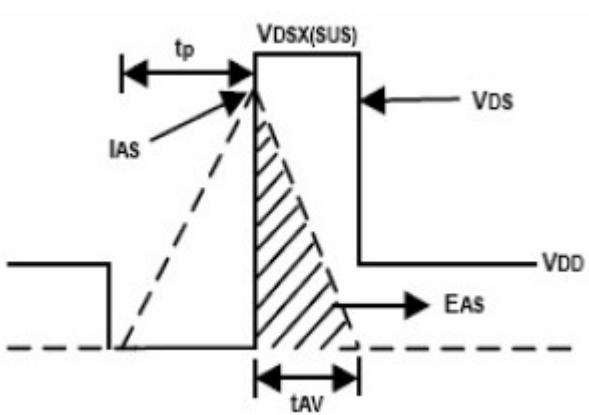
**Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	95			V
$I_{DSS}$	Zero Gate Voltage Drain Current( $T_c=25^\circ C$ )	$V_{DS}=95V, V_{GS}=0V$			1	$\mu A$
$I_{DSS}$	Zero Gate Voltage Drain Current( $T_c=125^\circ C$ )	$V_{DS}=95V, V_{GS}=0V$			10	$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 100$	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2		4	V
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=40A$		5.2	6.3	$m\Omega$
<b>Dynamic Characteristics</b>						
$g_{FS}$	Forward Transconductance	$V_{DS}=10V, I_D=15A$	20			S
$C_{iss}$	Input Capacitance	$V_{DS}=25V, V_{GS}=0V, f=1.0MHz$		4080		PF
$C_{oss}$	Output Capacitance			1161		PF
$C_{rss}$	Reverse Transfer Capacitance			138		PF
$Q_g$	Total Gate Charge	$V_{DS}=20V, I_D=5A, V_{GS}=10V$		60		nC
$Q_{gs}$	Gate-Source Charge			18		nC
$Q_{gd}$	Gate-Drain Charge			14		nC
<b>Switching Times</b>						
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=30V, I_D=40A, R_L=15\Omega, V_{GS}=10V, R_G=2.5\Omega$		15		nS
$t_r$	Turn-on Rise Time			32.3		nS
$t_{d(off)}$	Turn-Off Delay Time			24		nS
$t_f$	Turn-Off Fall Time			15		nS
<b>Source-Drain Diode Characteristics</b>						
$I_{SD}$	Source-drain Current(Body Diode)			118		A
$I_{SDM}$	Pulsed Source-Drain Current(Body Diode)			472		A
$V_{SD}$	Forward On Voltage <sup>(Note 1)</sup>	$T_J=25^\circ C, I_{SD}=40A, V_{GS}=0V$		0.9	0.99	V
$t_{rr}$	Reverse Recovery Time <sup>(Note 1)</sup>	$T_J=25^\circ C, I_F=30A, di/dt=100A/\mu s$		45		nS
$Q_{rr}$	Reverse Recovery Charge <sup>(Note 1)</sup>			80		nC
$t_{on}$	Forward Turn-on Time	Intrinsic turn-on time is negligible(turn-on is dominated by $L_S+L_D$ )				

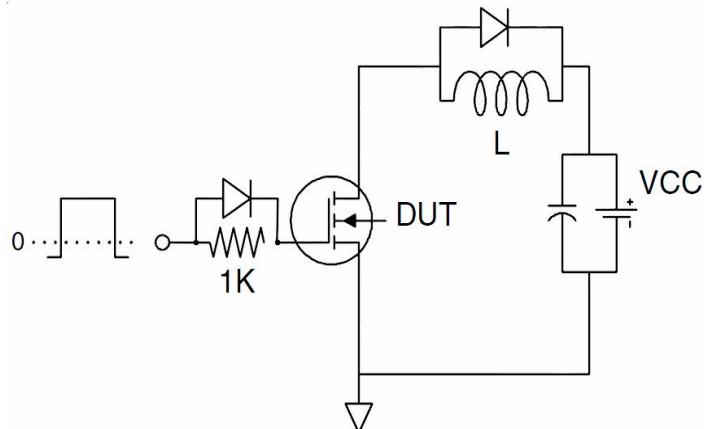
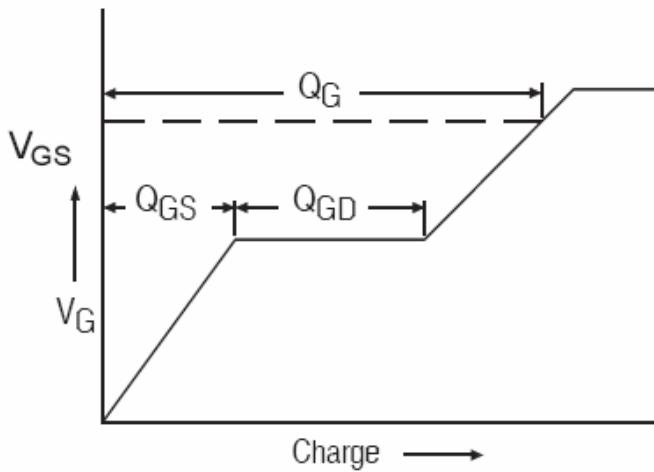
Notes 1.Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 1.5%,  $R_G=25\Omega$ , Starting  $T_J=25^\circ C$

## Test Circuit

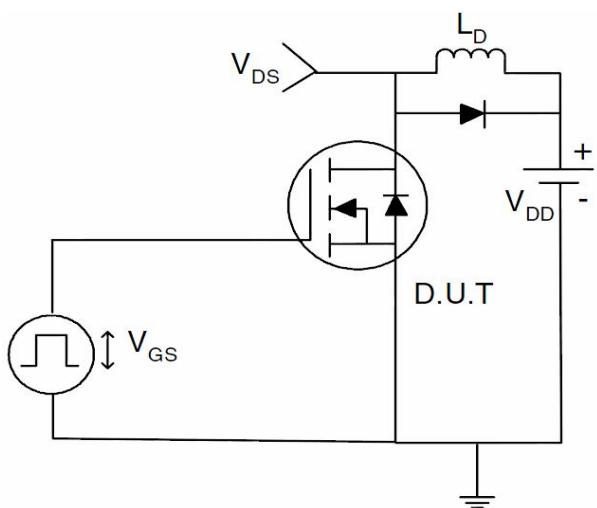
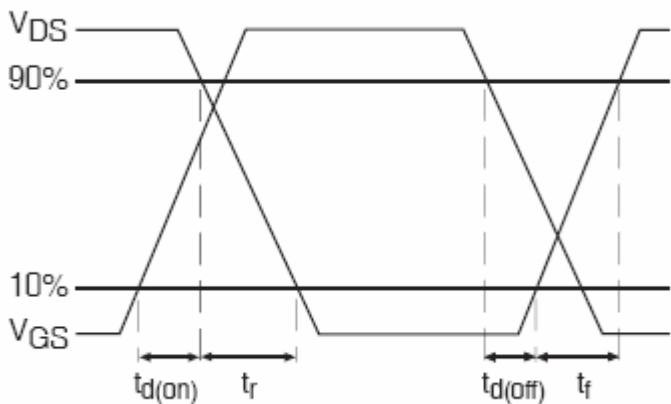
### 1) E<sub>AS</sub> Test Circuits



### 2) Gate Charge Test Circuit:



### 3) Switch Time Test Circuit:



## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)

Figure1. Output Characteristics

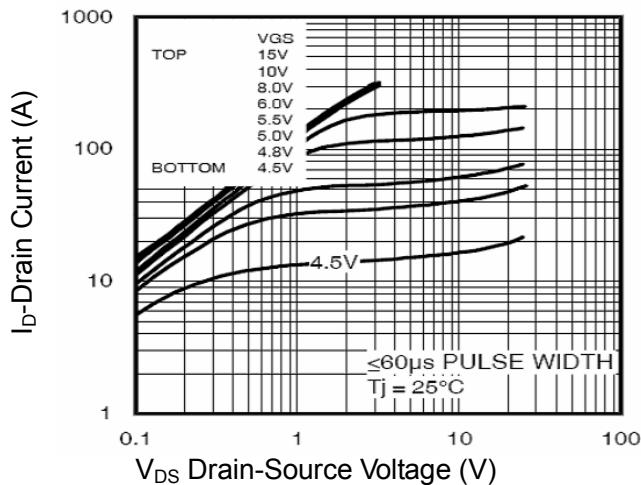


Figure2. Transfer Characteristics

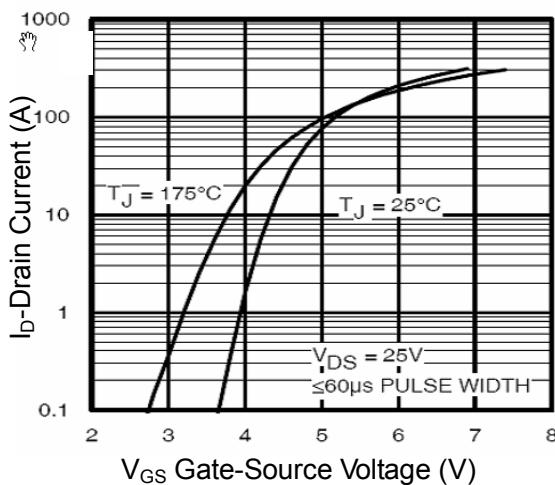


Figure3. BVDSS vs Junction Temperature

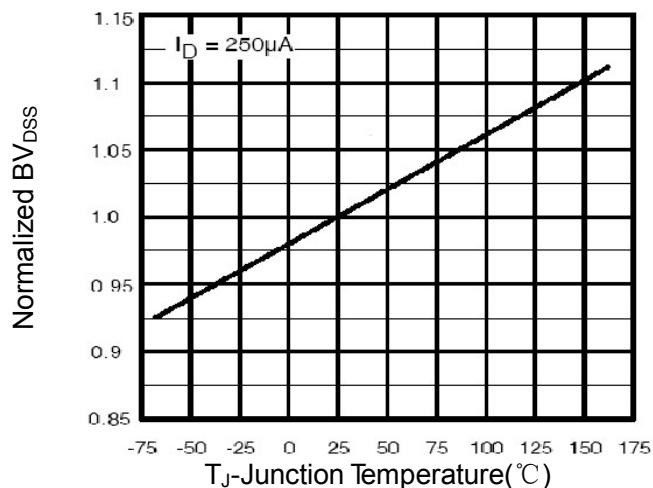


Figure4. ID vs Junction Temperature

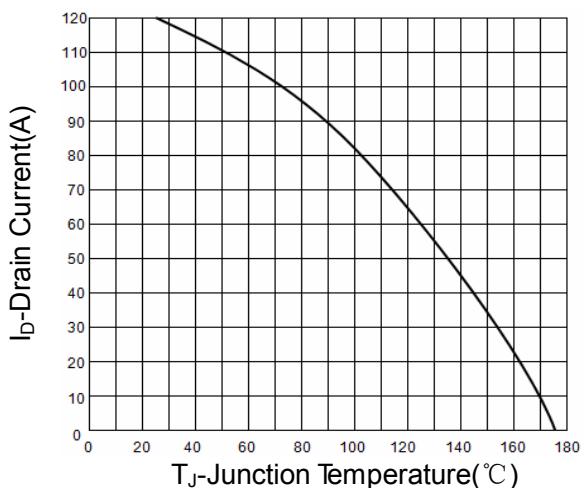


Figure5. VGS(th) vs Junction Temperature

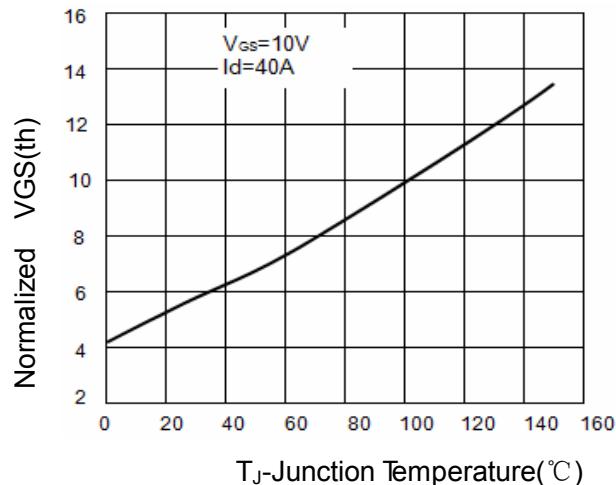
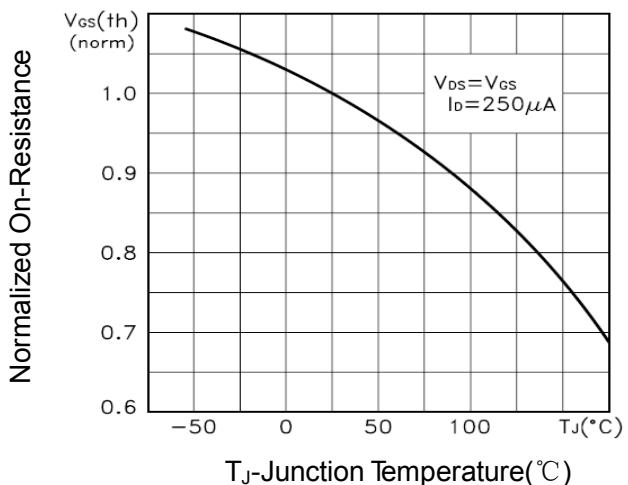
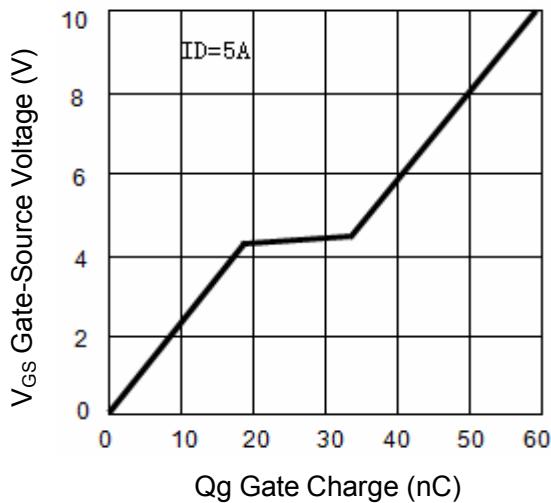


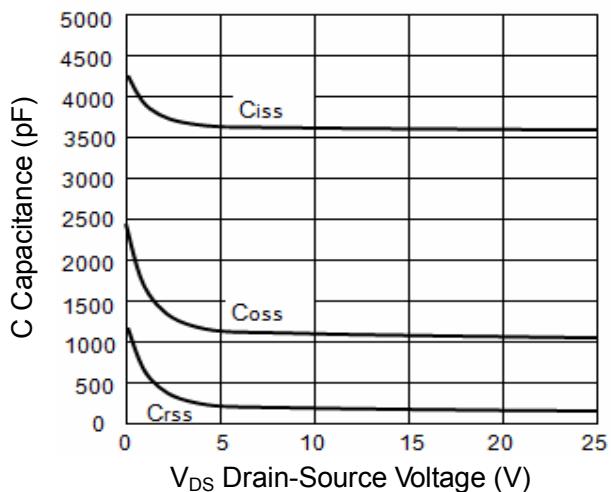
Figure6. Rdson Vs Junction Temperature



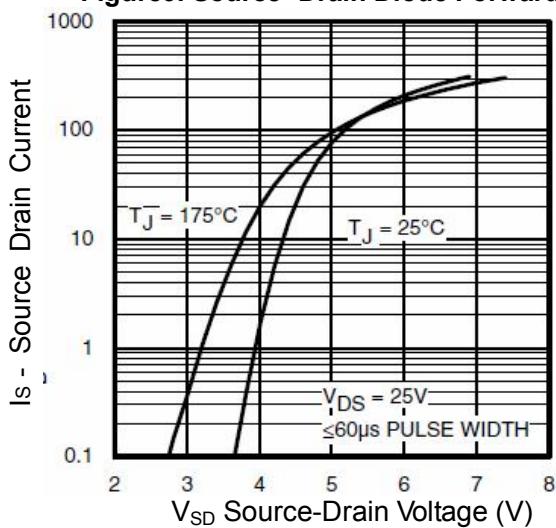
**Figure7. Gate Charge**



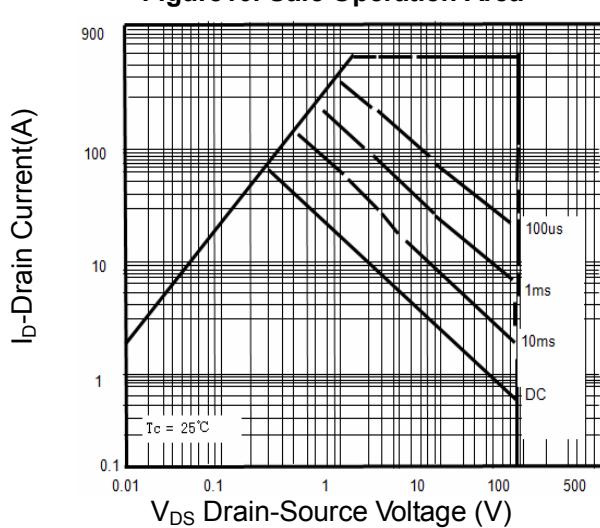
**Figure8. Capacitance vs Vds**



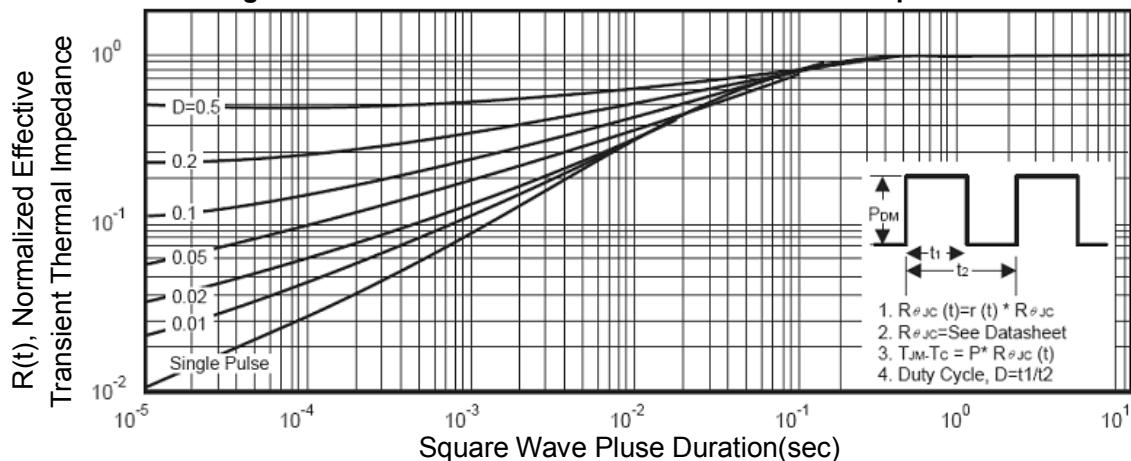
**Figure9. Source- Drain Diode Forward**



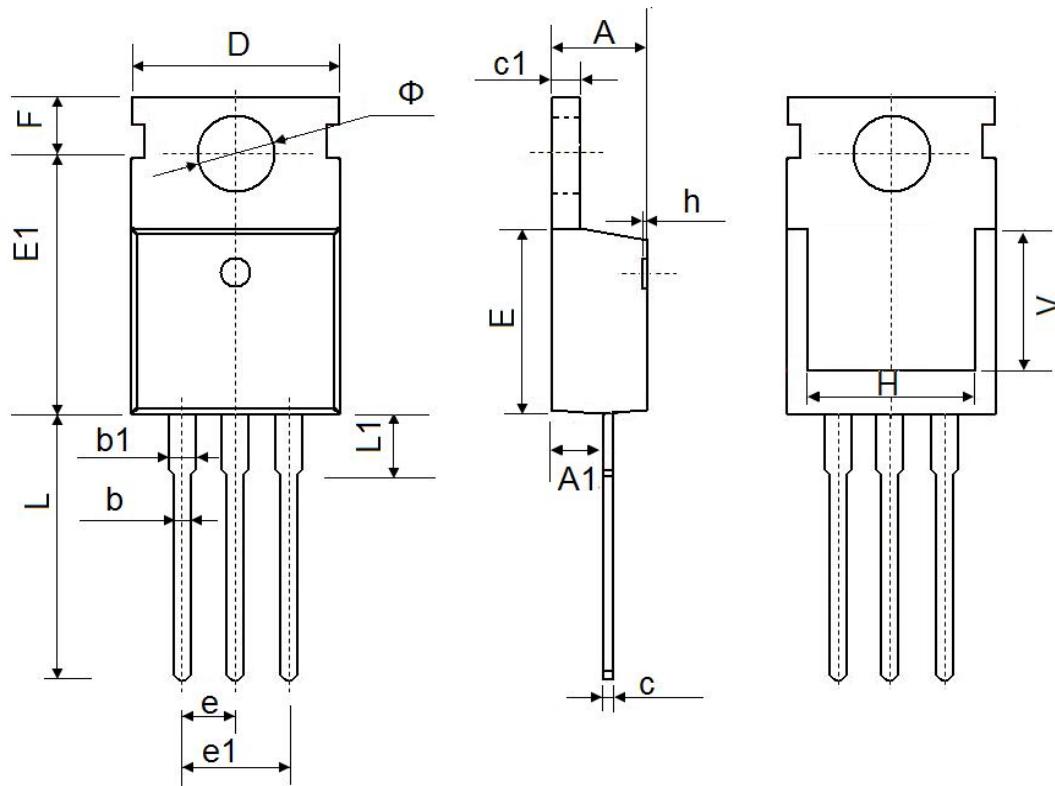
**Figure10. Safe Operation Area**



**Figure11. Normalized Maximum Transient Thermal Impedance**



## TO-220 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.300	4.700	0.169	0.185
A1	2.200	2.600	0.087	0.102
b	0.700	0.950	0.028	0.037
b1	1.170	1.410	0.046	0.056
c	0.450	0.650	0.018	0.026
c1	1.200	1.400	0.047	0.055
D	9.600	10.400	0.378	0.409
E	8.8500	9.750	0.348	0.384
E1	12.650	12.950	0.498	0.510
e	2.540 TYP.		0.100TYP.	
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
H	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.750	14.300	0.502	0.563
L1	2.850	3.950	0.112	0.156
V	7.500 REF.		0.295 REF.	
Φ	3.400	4.000	0.134	0.157